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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Application Serial No. 09/536,037
Filing Date March 27, 2000
Inventor Weimin (Michael) Li et al.
Assignee Micron Technology, Inc.
Group Art Unit 2822
Examiner T. Thomas
Attorney Docket No. MI22-1398
Title: Low k Interlevel Dielectric Layer Fabrication Methods

Assistant Commissioner for Patents
Washington, D.C. 20231

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2. Preliminary Amendment
3. Version with marking to show changes made

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PRELIMINARY AMENDMENT

To: Box Non Fee Amendment
 Assistant Commissioner for Patents
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Sir:

This is a preliminary amendment for the above-entitled patent application. Please enter the following amendments.